

# TinyLogic UHS Triple Inverter with Schmitt Trigger Input

# NC7NZ14

#### Description

The NC7NZ14 is a triple inverter with Schmitt trigger input from **onsemi**'s Ultra–High Speed (UHS) series of TinyLogic. The device is fabricated with advanced CMOS technology to achieve ultra–high speed with high output drive while maintaining low static power dissipation over a very broad  $V_{\rm CC}$  operating range. The device is specified to operate over the 1.65 V to 5.5 V  $V_{\rm CC}$  range. The inputs and outputs are high–impedance when  $V_{\rm CC}$  is 0 V. Inputs tolerate voltages up to 5.5 V independent of  $V_{\rm CC}$  operating voltage.

#### **Features**

- Ultra High-Speed:  $t_{PD}$  = 3.7 ns (Typical) into 50 pF at 5 V  $V_{CC}$
- High Output Drive: ±24 mA at 3 V V<sub>CC</sub>
- Broad V<sub>CC</sub> Operating Range: 1.65 V to 5.5 V
- Power Down High Impedance Inputs / Outputs
- Over-Voltage Tolerance Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise / EMI Reduction Circuitry
- Ultra-Small MicroPak<sup>TM</sup> Packages
- Space-Saving US8 Surface Mount Package
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

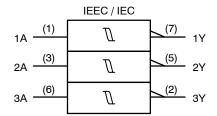


Figure 1. Logic Symbol

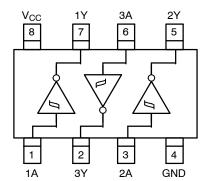


Figure 2. Connection Diagram (Top View)

#### MARKING DIAGRAMS



UQFN8 1.6X1.6, 0.5P CASE 523AY P6KK XYZ



US8 CASE 846AN



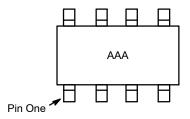
P6, NZ14 = Specific Device Code

KK = 2-Digit Lot Run Traceability Code
XY = 2-Digit Date Code Format
Z = Assembly Plant Code
A = Assembly Site
L = Wafer Lot Number
YW = Assembly Start Week

#### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information on page 6 of this data sheet.

# **Pin Configurations**



# NOTES:

- AAA represents product code top mark (see ordering table).
   Orientation of top mark determines pin one location. Reading the top product code mark left to right, pin one is the lower left pin.

Figure 3. US8

# 3Y 2A V<sub>CC</sub> 8 4 GND зА 2Y

Figure 4. MicroPak (Top Through View)

# **PIN DEFINITIONS**

Pin # US8	Pin # MicroPak	Name	Description
1	7	1A	Input
2	6	3Y	Output
3	5	2A	Input
4	4	GND	Ground
5	3	2Y	Output
6	2	ЗА	Input
7	1	1Y	Output
8	8	V <sub>CC</sub>	Supply Voltage

# **FUNCTION TABLE**

Input	Output
Α	Y
L	Н
Н	L

H = HIGH Logic Level L = LOW Logic Level

## NC7NZ14

## **ABSOLUTE MAXIMUM RATINGS**

Symbol	Param	Min	Max	Unit	
V <sub>CC</sub>	Supply Voltage	-0.5	6.5	V	
V <sub>IN</sub>	DC Input Voltage		-0.5	6.5	V
V <sub>OUT</sub>	DC Output Voltage		-0.5	6.5	V
I <sub>IK</sub>	DC Input Diode Current	V <sub>IN</sub> < 0 V	-	-50	mA
I <sub>OK</sub>	DC Output Diode Current	V <sub>OUT</sub> < 0 V	-	-50	mA
I <sub>OUT</sub>	DC Output Current		-	±50	mA
I <sub>CC</sub> / I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current		-	±50	mA
T <sub>STG</sub>	Storage Temperature Range		-65	+150	°C
$T_J$	Junction Temperature Under Bias	3	-	+150	°C
$T_L$	Junction Lead Temperature (Sold	ering, 10 Seconds)	-	+260	°C
$P_{D}$	Power Dissipation in Still Air	US8	-	500	mW
		MicroPak-8	-	539	
ESD	Human Body Model, JEDEC: JESD22-A114		-	4000	V
	Charge Device Model, JEDEC: JI	ESD22-C101	-	2000	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

## RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage Operating		1.65	5.5	V
	Supply Voltage Data Retention		1.5	5.5	
V <sub>IN</sub>	Input Voltage		0	5.5	V
V <sub>OUT</sub>	Output Voltage		0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature		-40	+85	°C
$\theta_{JA}$	Thermal Resistance	US8	-	250	°C/W
		MicroPak-8	_	232	1

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

<sup>3.</sup> Unused inputs must be held HIGH or LOW. They may not float.

# NC7NZ14

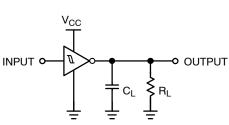
# DC ELECTICAL CHARACTERISTICS

				T <sub>A</sub> = +25°C			T <sub>A</sub> = -40	to +85°C	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min	Тур	Max	Min	Max	Unit
$V_P$	Positive Threshold Voltage	1.65		-	1.10	1.50	_	1.50	V
		2.30		-	1.40	1.80	_	1.80	
		3.00		-	1.75	2.20	_	2.20	
		4.50		-	2.45	3.10	_	3.10	
		5.50		-	2.90	3.60	_	3.60	
V <sub>N</sub>	Negative Threshold Voltage	1.65		0.25	0.55	-	0.25	-	V
		2.30		0.40	0.75	-	0.40	-	
		3.00		0.60	1.00	-	0.60	-	
		4.50		1.00	1.43	_	1.00	-	
		5.50		1.20	1.70	_	1.20	-	
V <sub>H</sub>	Hysteresis Voltage	1.65		0.15	0.54	1.00	0.15	1.00	V
		2.30		0.25	0.65	1.10	0.25	1.10	
		3.00		0.40	0.77	1.20	0.40	1.20	
		4.50		0.60	1.01	1.50	0.60	1.50	
		5.50		0.70	1.18	1.70	0.70	1.70	
V <sub>OH</sub>	HIGH Level Output Voltage	1.65	$V_{IN} = V_P \text{ or } V_N,$ $I_{OH} = -100  \mu\text{A}$	1.55	1.65	-	1.55	-	V
		2.30		2.20	2.30	-	2.20	-	
		3.00		2.90	3.00	-	2.90	-	
		4.50		4.40	4.50	-	4.4	-	
		1.65	I <sub>OH</sub> = -4 mA	1.29	1.52	-	1.29	-	
		2.30	I <sub>OH</sub> = -8 mA	1.90	2.15	-	1.90	-	
		3.00	I <sub>OH</sub> = -16 mA	2.40	2.80	-	2.40	-	
		3.00	I <sub>OH</sub> = -24 mA	2.30	2.68	-	2.30	-	
		4.50	I <sub>OH</sub> = -32 mA	3.80	4.20	-	3.80	-	
V <sub>OL</sub>	LOW Level Output Voltage	1.65	$V_{IN} = V_P \text{ or } V_N,$	-	0.00	0.10	_	0.10	V
		2.30	l <sub>OL</sub> = 100 μA	-	0.00	0.10	_	0.10	
		3.00		-	0.00	0.10	-	0.10	
		4.50		-	0.00	0.10	-	0.10	
		1.65	I <sub>OL</sub> = 4 mA	-	0.08	0.24	_	0.24	
		2.30	I <sub>OL</sub> = 8 mA	-	0.10	0.30	_	0.30	
		3.00	I <sub>OL</sub> = 16 mA	-	0.15	0.40	_	0.40	1
		3.00	I <sub>OL</sub> = 24 mA	-	0.22	0.55	_	0.55	1
		4.50	I <sub>OL</sub> = 32 mA	-	0.22	0.55	_	0.55	1
I <sub>IN</sub>	Input Leakage Current	1.65 to 5.5	V <sub>IN</sub> = 5.5 V, GND	-	-	±0.1	-	±1.0	μΑ
I <sub>OFF</sub>	Power Off Leakage Current	0	V <sub>IN</sub> or V <sub>OUT</sub> = 5.5 V	-	-	1	_	10	μΑ
I <sub>CC</sub>	Quiescent Supply Current	1.65 to 5.50	V <sub>IN</sub> = 5.5 V, GND	-	_	1.0	_	10	μΑ

## **AC ELECTRICAL CHARACTERISTICS**

				T <sub>A</sub> = +25°C		T <sub>A</sub> = -40 to +85°C			
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min	Тур	Max	Min	Max	Unit
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay	1.80 ±0.15		-	7.6	12.5	-	13.0	ns
	(Figure 5, 6)	2.50 ±0.20	$R_L = 1 M\Omega$ ,	-	5.0	9.0	-	9.5	
		3.30 ±0.30		-	3.7	6.3	_	6.5	
		5.00 ±0.50		-	3.1	5.2	-	5.5	
		3.30 ±0.30	$C_L = 50 \text{ pF},$ $R_L = 500 \Omega,$	-	4.4	7.2	_	7.5	
		5.00 ±0.50	nL = 500 \$2,	-	3.7	5.9	-	6.2	
C <sub>IN</sub>	Input Capacitance	0.00		-	2.5	-	-	-	pF
C <sub>PD</sub>	Power Dissipation Capacitance (Note 4) (Figure 7)	3.30		-	9	-	_	-	pF
		5.00		-	11	-	_	-	

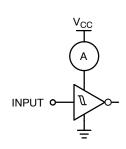
<sup>4.</sup> C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I<sub>CCD</sub>) at no output loading and operating at 50% duty cycle. C<sub>PD</sub> is related to I<sub>CCD</sub> dynamic operating current by the expression:
I<sub>CCD</sub> = (C<sub>PD</sub>) (V<sub>CC</sub>) (f<sub>IN</sub>) + (I<sub>CC</sub>static).



NOTE:

 C<sub>L</sub> includes load and stray capacitance; Input PRR = 1.0 MHz, t<sub>W</sub> = 500 ns.

Figure 5. AC Test Circuit



NOTE:

6. Input = AC Waveform;  $t_r$  =  $t_f$  = 1.8 ns; PRR = 10 MHz; Duty Cycle = 50%.

Figure 7.  $I_{CCD}$  Test Circuit

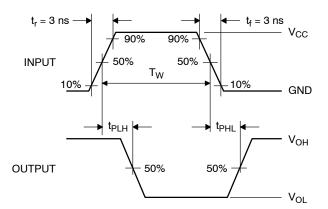


Figure 6. AC Waveforms

## NC7NZ14

## **ORDERING INFORMATION**

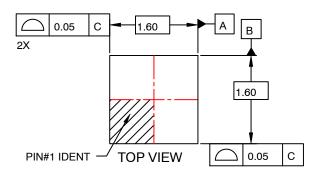
Part Number	Top Mark	Package	Shipping <sup>†</sup>
NC7NZ14K8X	NZ14	8-Lead US8, JEDEC MO-187, Variation CA 3.1 mm Wide	3000 / Tape & Reel
NC7NZ14L8X	P6	8-Lead MicroPak, 1.6 mm Wide	5000 / Tape & Reel
NC7NZ14L8X-L22185	P6	8-Lead MicroPak, 1.6 mm Wide	5000 / Tape & Reel

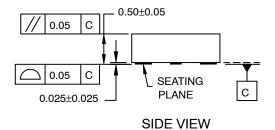
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

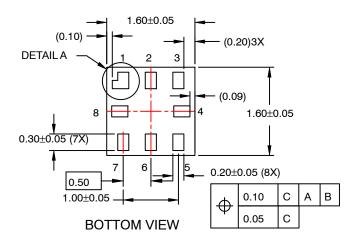
MicroPak is trademark of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries.

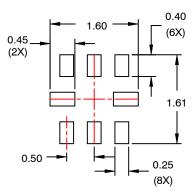
UQFN8 1.6X1.6, 0.5P CASE 523AY ISSUE O

**DATE 31 AUG 2016** 





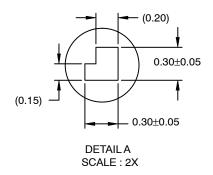




RECOMMENDED LAND PATTERN

#### NOTES:

- A. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.

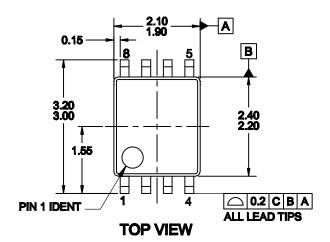


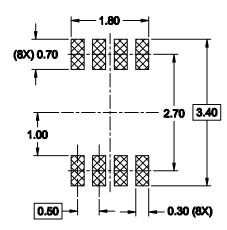
DOCUMENT NUMBER:	98AON13591G	Electronic versions are uncontrolled except when accessed directly from Printed versions are uncontrolled except when stamped "CONTROLLED (	
DESCRIPTION:	UQFN8 1.6X1.6, 0.5P		PAGE 1 OF 1

ON Semiconductor and a re trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

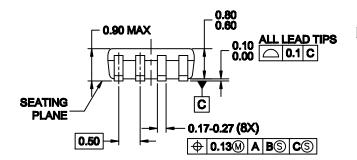
US8 CASE 846AN ISSUE O

**DATE 31 DEC 2016** 





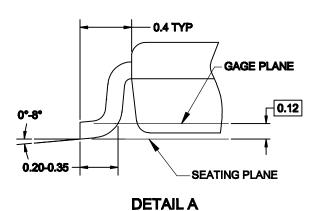
# **RECOMMENDED LAND PATTERN**

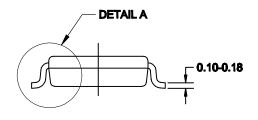


# **NOTES:**

- A. CONFORMS TO JEDEC REGISTRATION MO-187
- **B. DIMENSIONS ARE IN MILLIMETERS.**
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1994.

# **SIDE VIEW**





DOCUMENT NUMBER:	98AON13778G	Electronic versions are uncontrolled except when accessed directly from the Document Report Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.			
DESCRIPTION:	US8		PAGE 1 OF 1		

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMi., and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer p

#### **PUBLICATION ORDERING INFORMATION**

LITERATURE FULFILLMENT: Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative